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(54) HEADPHONE DEVICE

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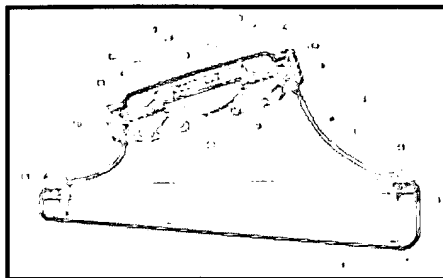
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(57) A headphone device where a back housing provided behind a driver unit of a headphone unit and a baffle section provided at a front face are formed from a porous material having air permeability. The headphone device is a device where a baffle section constructed so as to surround a space except a front opening of a driver unit and/or a back housing section constructed so as to cover the rear face of the driver unit are formed using a porous material having air permeability.



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